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Declarations under Rule 4.17:

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(54) Title: CURABLE SILICONE COMPOSITIONS HAVING IMPROVED ADHESION TO POLYMERIC FILMS

(57) Abstract: The present invention relates to curable silicone coating compositions having improved adhesion to polymeric substrates. The present invention also relates to additives that improve adhesion of silicone pressure sensitive adhesive coating compositions to polymeric substrates. Furthermore the present invention relates to the process for making a silicone pressure sensitive adhesive coating with improved adhesion to polymeric substrates.

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